

DARLINGTON POWER TRANSISTOR 2SA1841

PNP SILICON EPITAXIAL TRANSISTOR (DARLINGTON CONNECTION) FOR HIGH-SPEED SWITCHING

The 2SA1841 is a high-speed Darlington power transistor. This transistor is ideal for high-precision control such as PWM control for pulse motors or brushless motors in OA and FA equipment.

In addition, this transistor features a package that can be auto-mounted in radial taping specifications, thus contributing to mounting cost reduction.

FEATURES

- · Auto-mounting possible in radial taping specifications
- Resin-molded insulation type package with power rating of 1.8 W in stand-alone conditions
- High DC current amplifiers due to Darlington connection $h_{FE} = 4,000$ to 20,000 @VcE = -2.0 V, Ic = -4.0 A
- On-chip C-to-E reverse diode
- · Fast switching speed

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Conditions	Ratings	Unit
Collector to base voltage	Vcво		-100	V
Collector to emitter voltage	VCEO		-100	٧
Emitter to base voltage	VEBO		-8.0	V
Collector current (DC)	Ic(DC)		-8.0	Α
Collector current (pulse)	IC(pulse)	PW ≤ 10 ms, duty cycle ≤ 2%	-16	Α
Base current (DC)	I _{B(DC)}		-0.8	Α
Total power dissipation	Рт	Ta = 25°C	1.8	W
Junction temperature	Tj		150	°C
Storage temperature	Tstg		-55 to +150	°C

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = -100 V, IE = 0			-1.0	μΑ
Collector cutoff current	ІЕВО	$V_{EB} = -5.0 \text{ V}, \text{ Ic} = 0$			-5.0	mA
DC current gain	h _{FE1} *	$V_{CE} = -2.0 \text{ V, Ic} = -4.0 \text{ A}$	4,000		20,000	_
DC current gain	h _{FE2} *	$V_{CE} = -2.0 \text{ V, Ic} = -8.0 \text{A}$	500			_
Collector saturation voltage	V _{CE(sat)} *	Ic = -4.0 A, IB = -4.0 mA			-1.5	٧
Base saturation voltage	V _{BE(sat)} *				-2.0	٧
Turn-on time	ton	Ic = -4.0 A		0.2		μs
Storage time	tstg	$I_{B1} = -I_{B2} = -4.0 \text{ mA}$ $R_L = 12.5 \Omega, V_{CC} = -50 \text{ V}$		1.5		μs
Fall time	tf	11L - 12.0 32, VOC30 V		0.7		μs

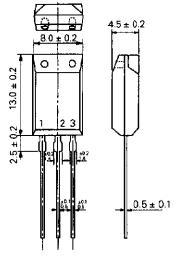
^{*} Pulse test PW \leq 350 μ s, duty cycle \leq 2%

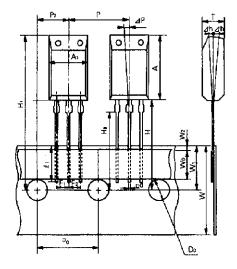
hfe CLASSIFICATION

Marking	L	κ		
h _{FE2}	4,000 to 10,000	8,000 to 20,000		

PACKAGE DRAWING (UNIT: mm)

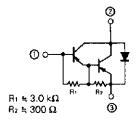
TAPING SPECIFICATION





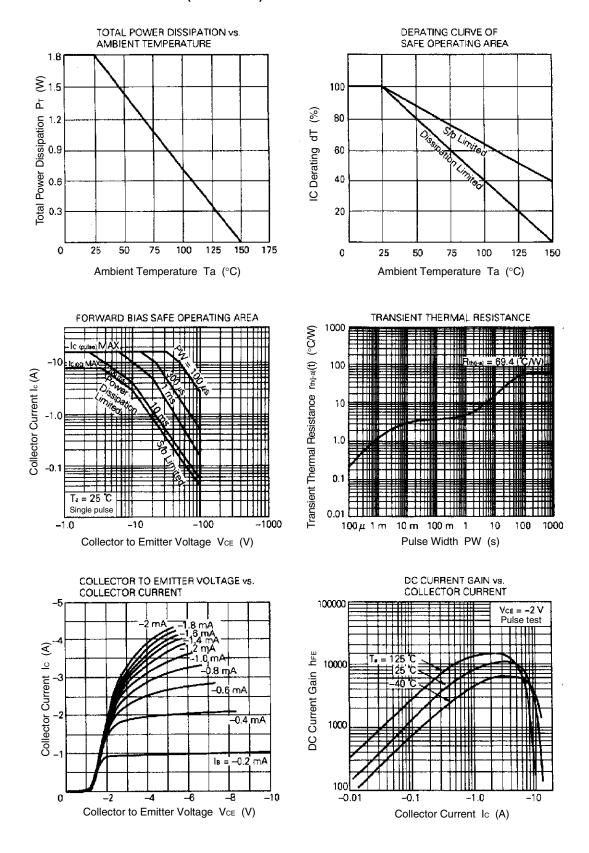
Αı	8.0 ± 0.2
Α	13.0 ± 0.2
D₀	φ4.0 ± 0.2
d	0.5 ± 0.1
F ₁	2.5 -0.4
F₂	2.5+0.4
Н :	20.0 MAX.
Н₀	16.0 ± 0.5
Hi :	32.2 MAX.
⊿h	0 ± 1.0
ℓ_1	2.5 MIN.
Р	12.7 ± 1.0
Po	12.7 ± 0.3
P ₂	6.35 ± 0.5
⊿P	0 ± 1.3
T	4.5 ± 0.2
W	18.0 ^{+1.0}
₩o	5.0 MIN.
W٠	9.0 ± 0.5
W_2	0.7 MIN.

- Electrode Connection
- 1. Base
- 2. Collector
- 3. Emitter

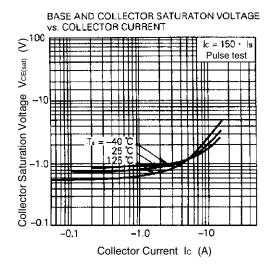


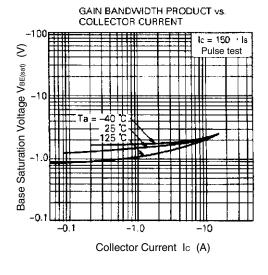


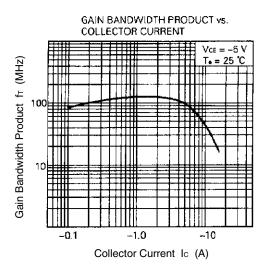
TYPICAL CHARACTERISTICS (Ta = 25°C)

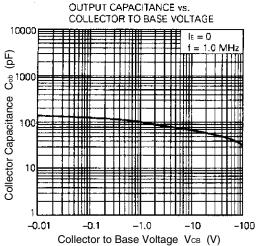


Data Sheet D15590EJ2V0DS 3



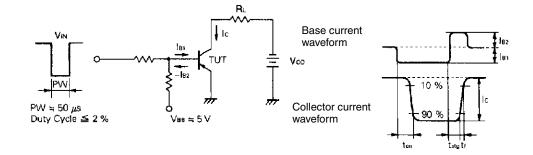








SWITCHING TIME (ton, tstg, tf) TEST CIRCUIT



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